IN THE CLAIMS:

- (original) A pressure sensor comprising
- a substrate with an opening; and
- a flexible diaphragm held across the opening of the substrate

wherein at temperatures of at least about 200 °C, the pressure sensor has a gage factor of at least about 27.

- 2. (original) The pressure sensor in claim 1, wherein the pressure sensor has a gage factor of at least about 32.
- 3. (original) The pressure sensor in claim 1, wherein the pressure sensor has a gage factor of at least about 37.
- 4. (original) The pressure sensor in claim 1, wherein at temperatures of at least about 400 °C, the pressure sensor has a gage factor of at least about 22.
- 5. (original) The pressure sensor in claim 4, wherein the pressure sensor has a gage factor of at least about 30.
- 6. (original) The pressure sensor in claim 4, wherein the pressure sensor has a gage factor of at least about 35.
- 7. (original) The pressure sensor in claim 1, wherein at temperatures of at least about 550 °C, the pressure sensor has a gage factor of at least about 16.
- 8. (original) The pressure sensor in claim 7, wherein the pressure sensor has a gage factor of at least about 25.

- 9. (original) The pressure sensor in claim 7, wherein the pressure sensor has a gage factor of at least about 35.
- 10. (currently amended) A pressure sensor comprising
- a pressure sensing element; and
- a heating element capable of heating the <u>pressure</u> sensing element to at least about the application temperature of the pressure sensor.
- 11. (currently amended) The pressure sensor in claim 10, wherein the <u>pressure</u> sensing element is a strain gage.
- 12. (currently amended) The pressure sensor in claim 10, wherein the heating element is capable of heating the <u>pressure</u> sensing element to at least about the maximum application temperature of the pressure sensor.
- 13. (currently amended) The pressure sensor in claim 10, wherein the <u>pressure</u> sensing element is made from a shape memory alloy material.
- 14. (currently amended) The pressure sensor in claim 10, wherein the heating element heats the <u>pressure</u> sensing element to over 200 °C.
- 15. (original) The pressure sensor in claim 11, wherein the strain gage responds to deflection of a diaphragm.

a substrate with an opening having a maximum cross-sectional dimension of less than about 1.0 mm; and

a flexible diaphragm

wherein the pressure sensor is capable of measuring pressures of greater than 1000 psi without premature failure.

- 17. (original) The pressure sensor in claim 16, wherein the opening in the substrate has a maximum cross-sectional dimension of less than about 0.25 mm.
- 18. (original) The pressure sensor in claim 16, wherein the flexible diaphragm has a thickness of less than 350 um extending across the opening of the substrate.
- 19. (currently amended) The pressure sensor in claim 18, wherein the pressure sensor is capable of measuring pressures of greater than 1000 3000 psi without premature failure.
- 20. (original) The pressure sensor in claim 16, wherein the sensing element is made from a shape memory alloy material.